



**2022**

Annual **INCOSE**  
international workshop

**HYBRID EVENT**

Torrance, CA, USA

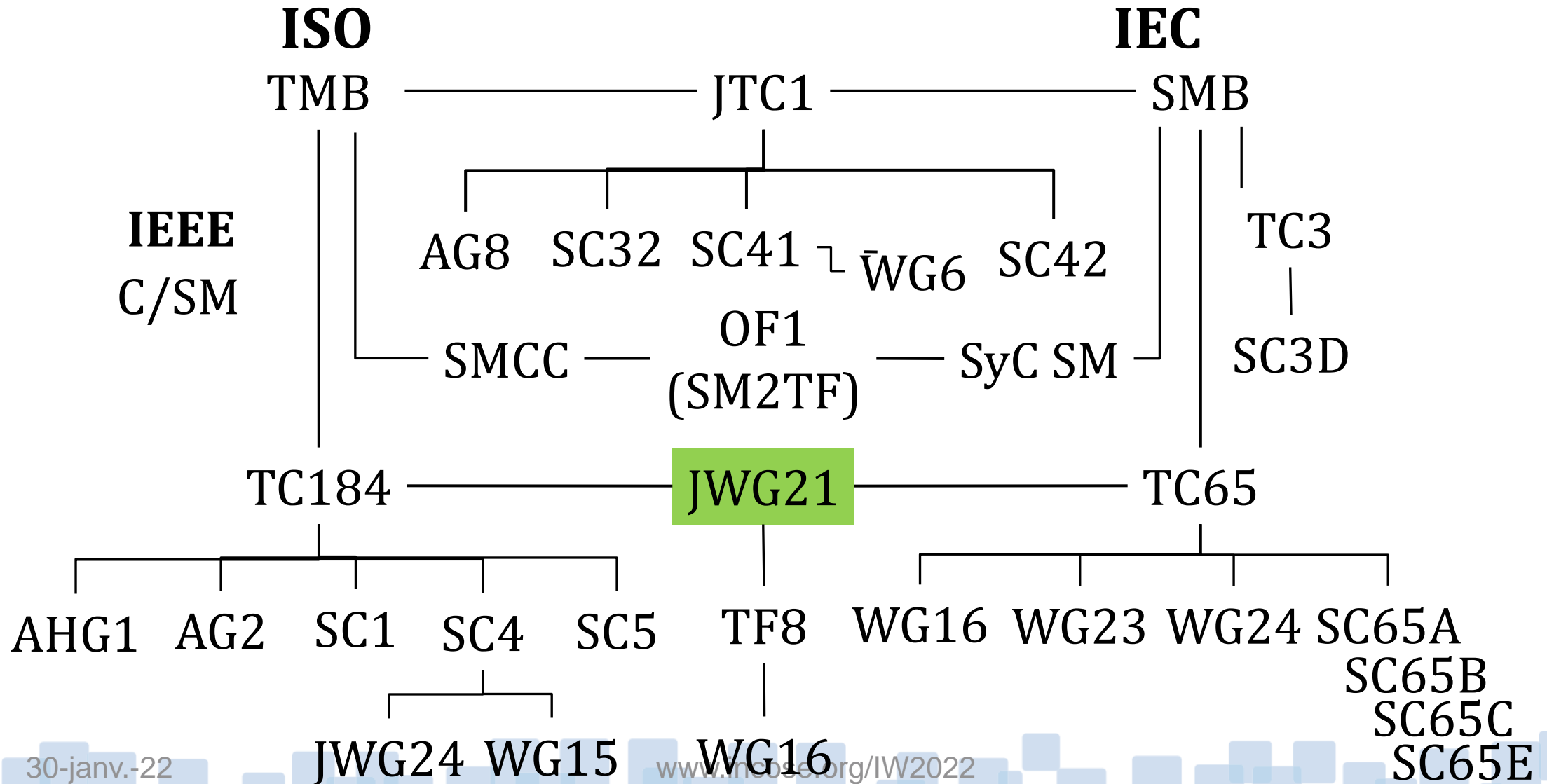
Jan 29 - Feb 1, 2022

MBSE Round-robin overview – Richard Martin

# IEC 63339 Unified smart manufacturing reference model



# IEC TC65 – ISO TC184 JWG21 realm



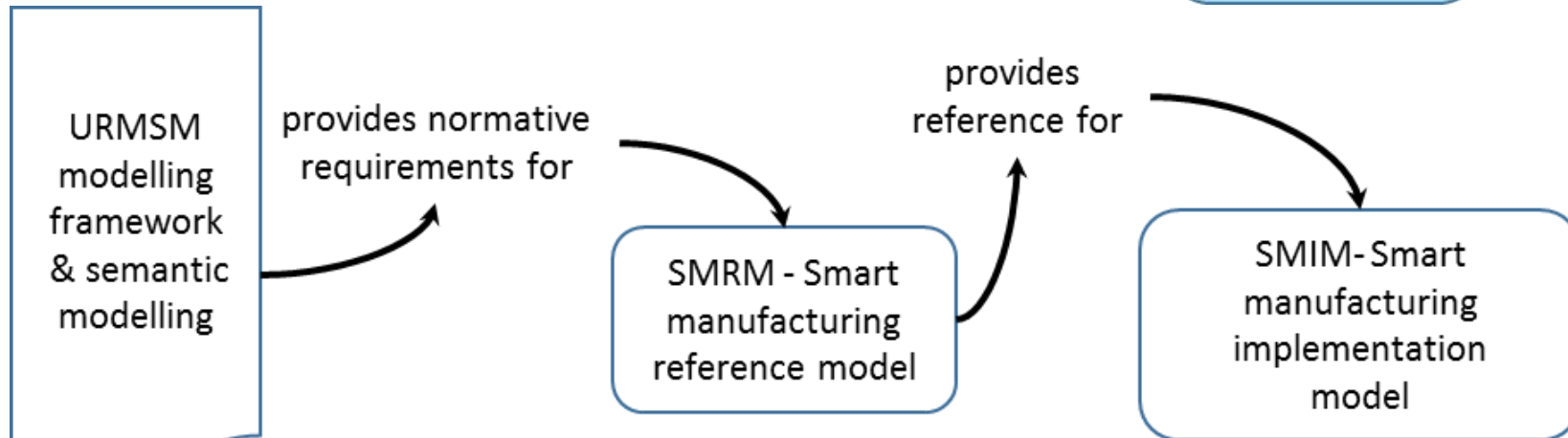
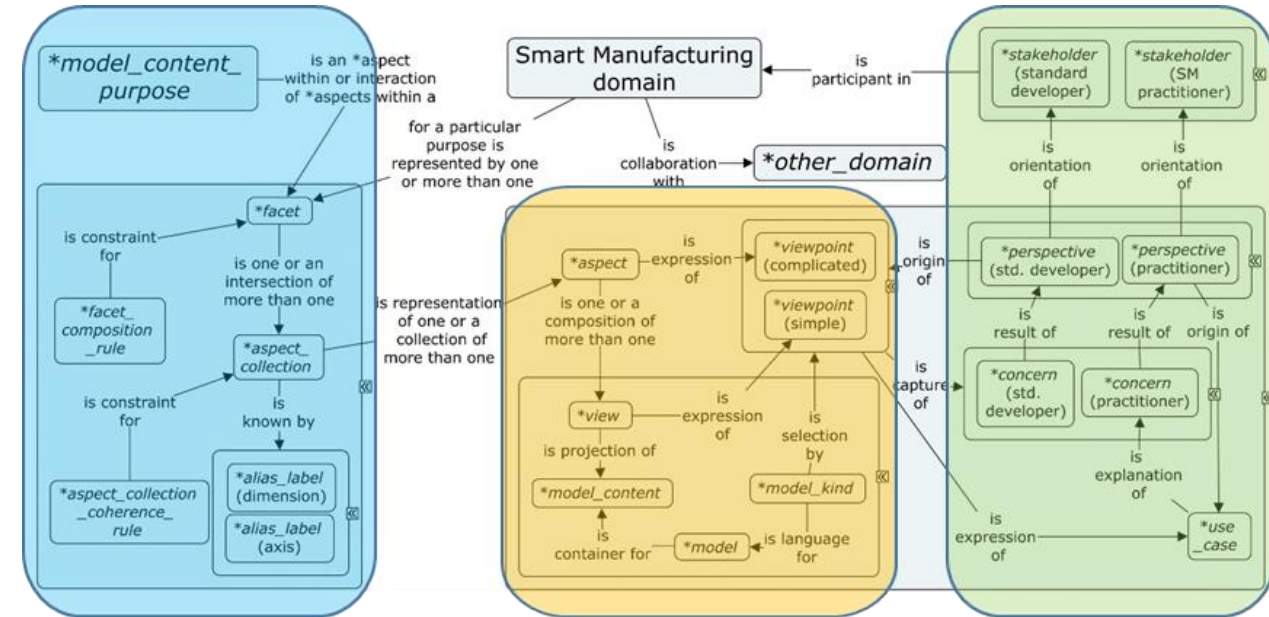
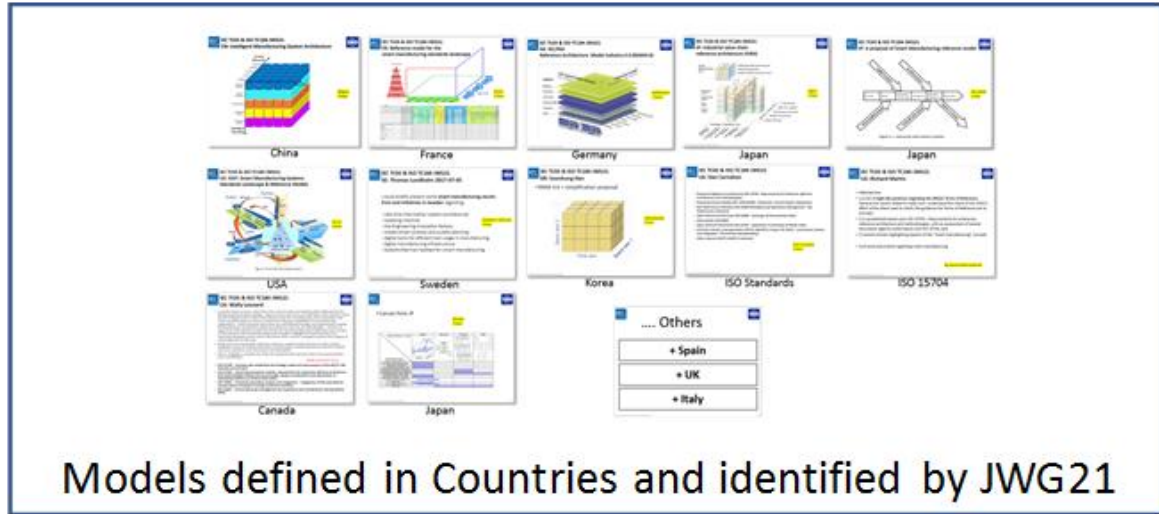


# JWG21 ToR and work products

- JWG shall prepare a **standardized unified Reference Model** to support ISO TC184 and IEC TC65 activities in Smart Manufacturing.
- The Reference Model shall comprise a **single model, possibly with a set of consistent and coherent sub-models**, and align with the requirements of stakeholder groups, including manufacturing system users, suppliers, integrators, standardisers, and consumers of manufactured products.
- IEC TR 63319: A **meta-modelling analysis approach** to smart manufacturing reference models. Approved in 2020-10, To be published in 2022-03.
- IEC 63339: Unified reference model for smart manufacturing is a **set of requirements and specifications** for smart manufacturing reference models .



# IEC 63319 TR result



Heavy influence from ISO/IEC/IEEE 42010 & ISO 15704

# Unifying theme elements



- State reference model context and purpose
- Utilize semantic models of aspects identified as characteristics in the stated context relative to the stated purpose
- Collect aspects into coherent modelling dimensions, which then has its own semantic model
- Arrange dimensions into meaningful facets to understand aspect interactions
- Keep aligned with 63316 meta-model and URMSM formal model
- Enable heterogeneous ways to model smart manufacturing both graphically and mathematically

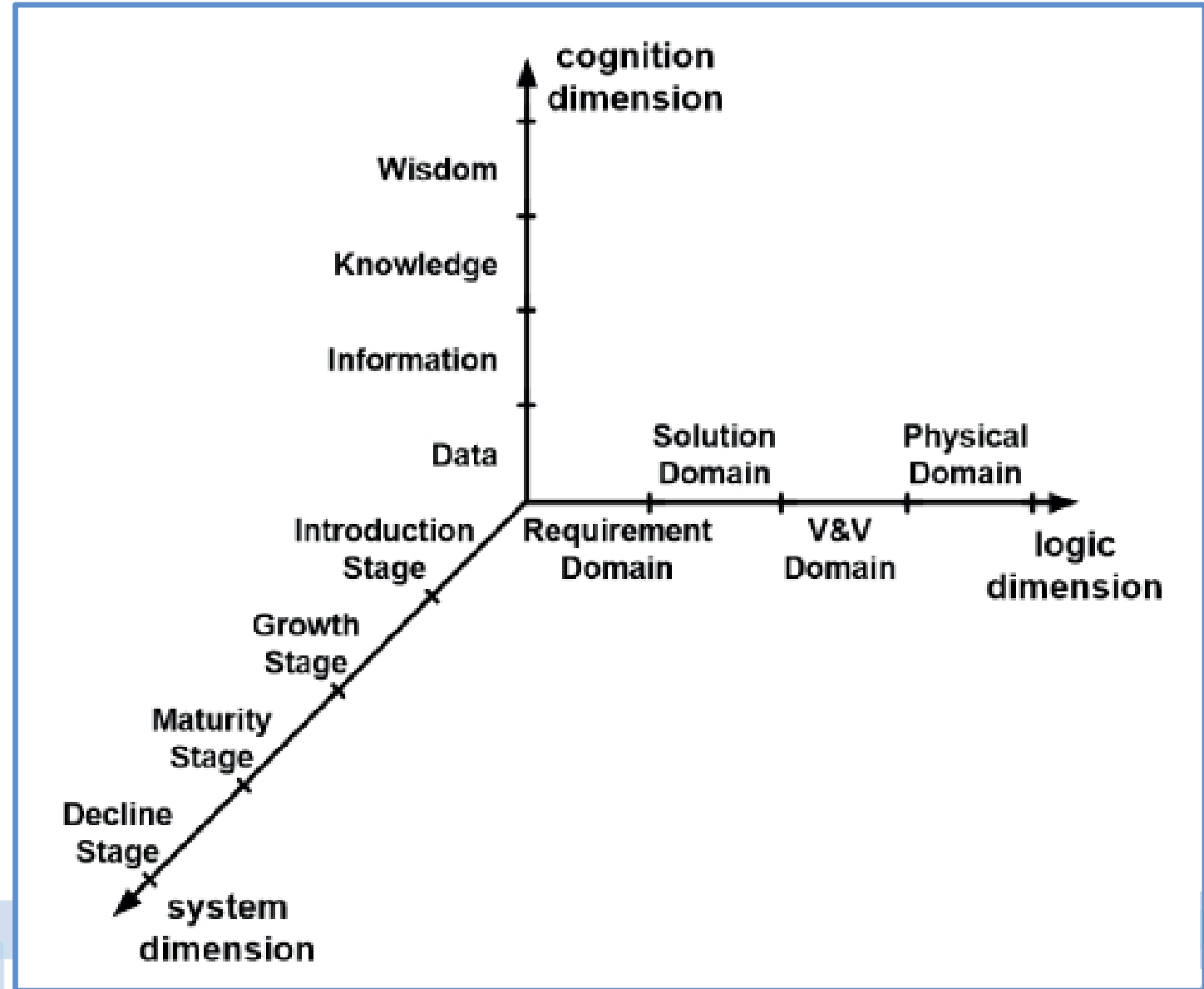
# Aspects, dimensions, facet – 24641 example



13 aspects – wisdom, knowledge, information, data, introduction stage, growth stage, maturity stage, decline stage, requirement domain, solution domain, V&V domain, physical domain

3 dimensions – cognitive, system, logic

1 facet – MBSSE Reference Framework

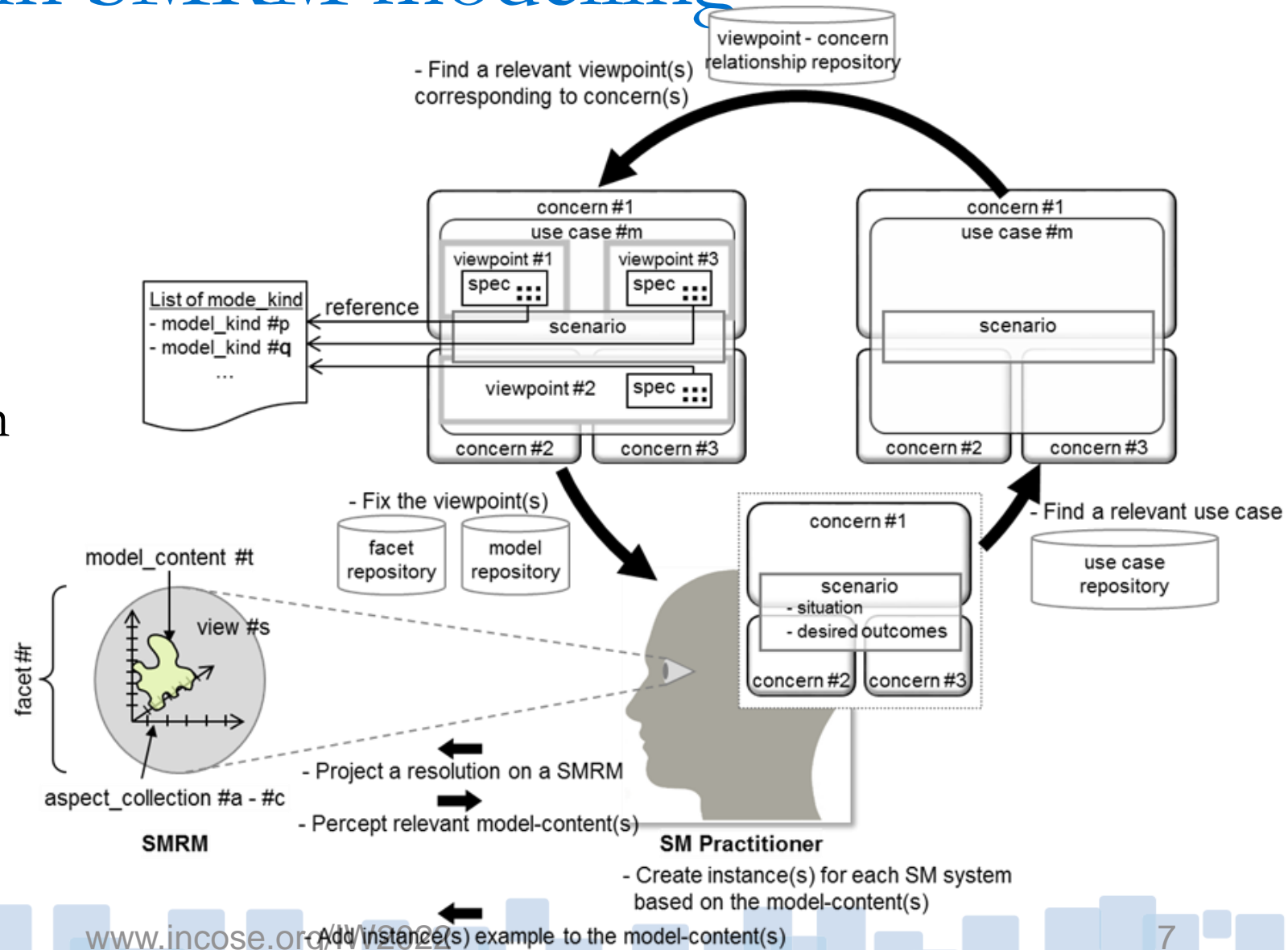




# Use of URMSM in SMRM modelling

Semantic content of an SMRM needs to address the concerns of practitioners, often stated as a use case.

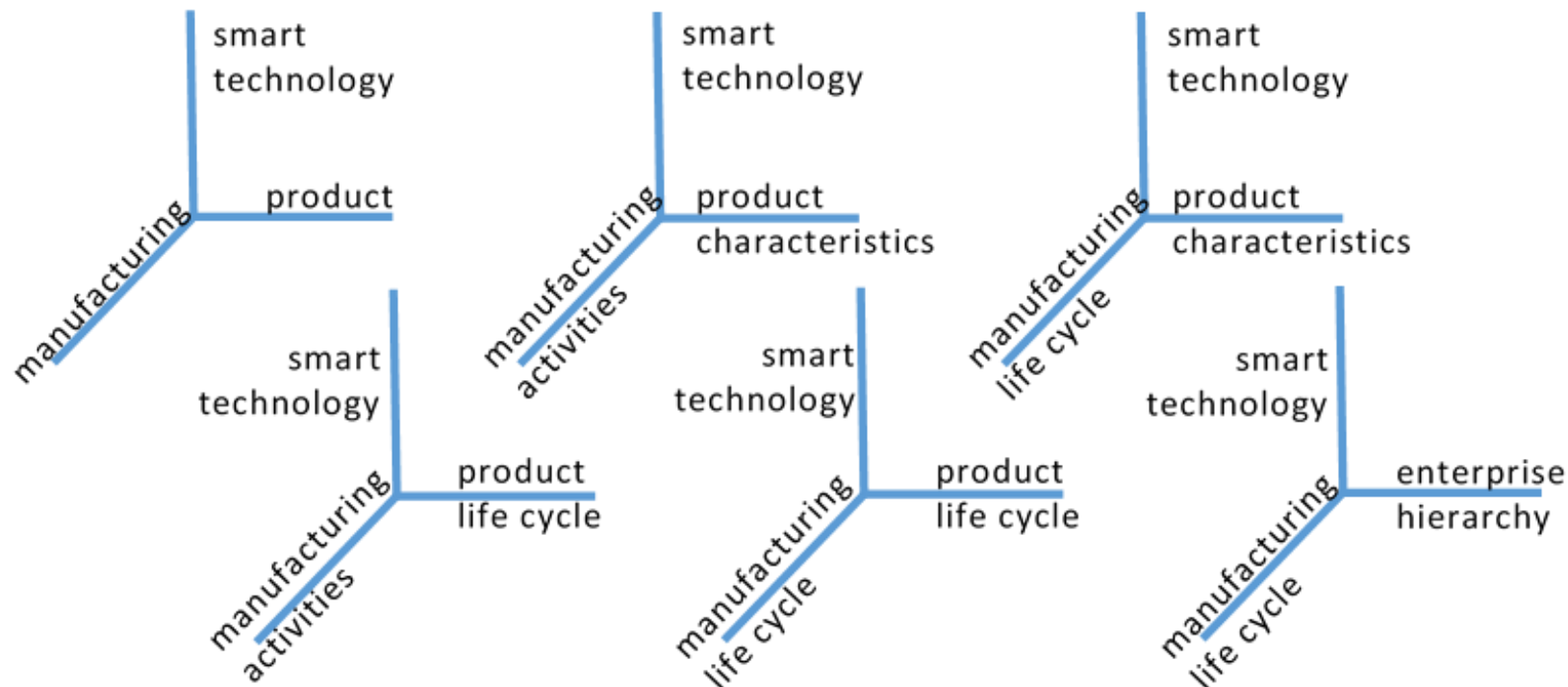
URMSM specifies the ways in which semantic content should be developed and deployed to support modelling activities of standards developers and practitioners.



# Families of reference models – 3D examples



- Multiple facets allow analysis or synthesis using aspects in many different dimensions.
- Modelling purpose determines which aspect interactions are meaningful.



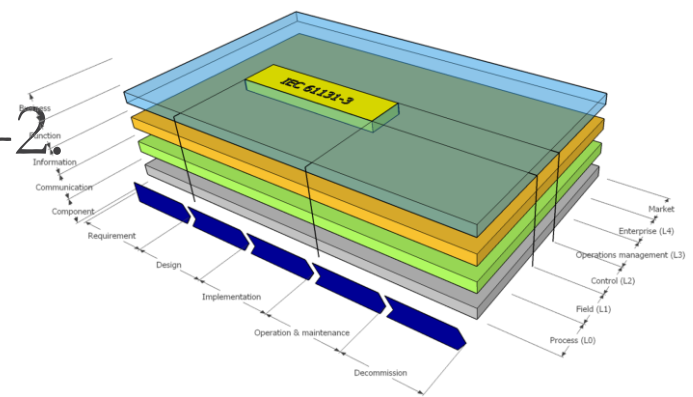




# Purpose specific content representation

- The same model content can appear in different representations to align with modelling purpose.
- The images are three ways of using content specified semantically in IEC 63306-1 and catalogued in IEC 63306-2.

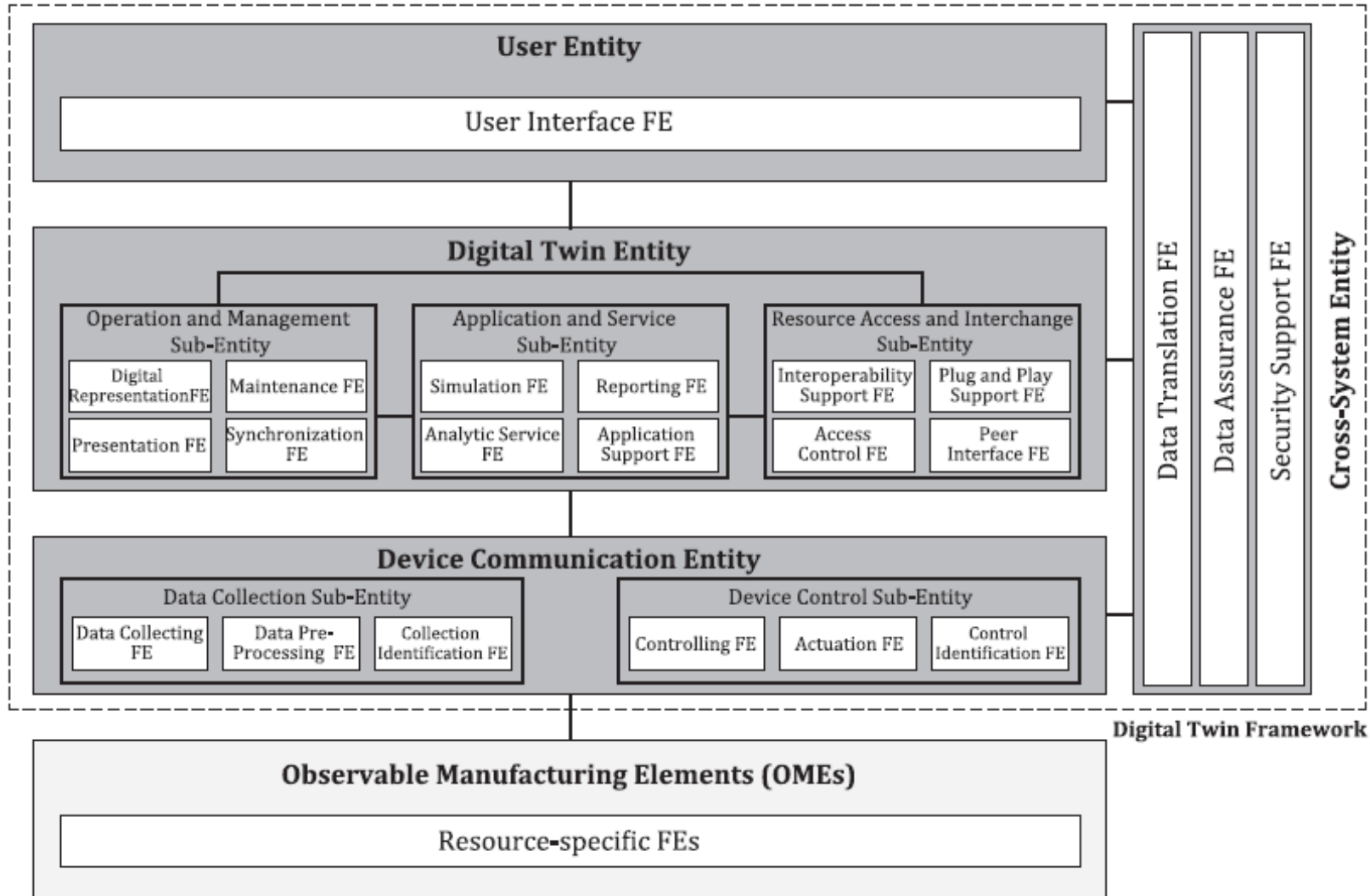
Object of standard				Hierarchy																				
Product activity	Production system activity	Type of standard		Equipment hierarchy level					Functional hierarchy level			Type	Instance	P										
		Terminology	Design requirements	Connected world	Enterprise	Site	Area	Work center	Work unit	Station/Equipment module	Control device/Control module	Field device	Product	L4: Business level	L3: Manufacturing Operation Management	L2: Control	L1: Sensors and actuators	LD: Process	type_development	type_maintenance/usage	instance_production	instance_maintenance/usage	Market analysis	Market requirements
						1	1												1	1	-	-		
						-	-												1	1	-	-		
						1	1												-	-	-	-		



	Product life cycle			
Activities			Sales	
Product model				
Catalog data			ISO 13584 IEC 61360 ISO 22745 IEC 62683 IEC 61987	
Lifecycle mngt				



# Many aspects and dimensions of digital twin

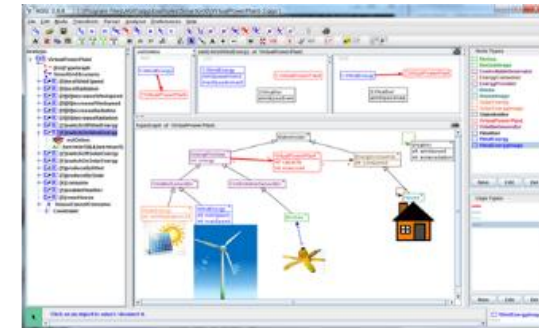
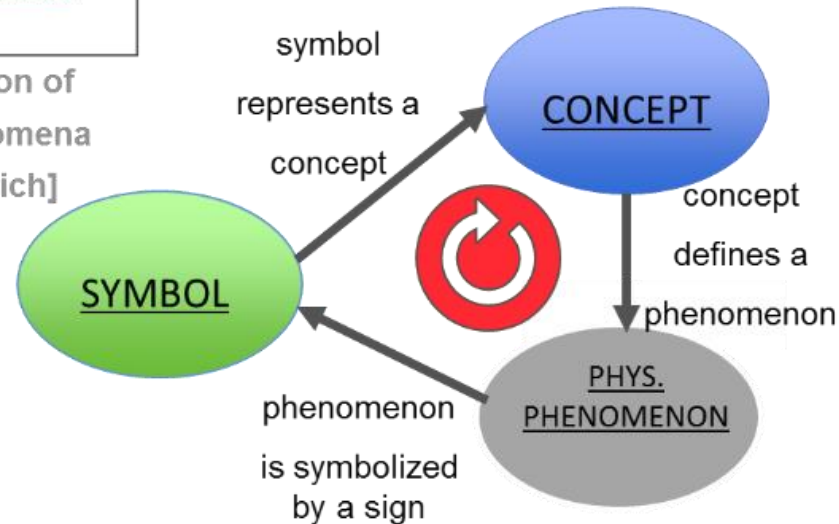


- More than 3 dimensions require different representational forms.
- The semantic models for digital twin are found in ISO 23247 Parts 1 – 4.

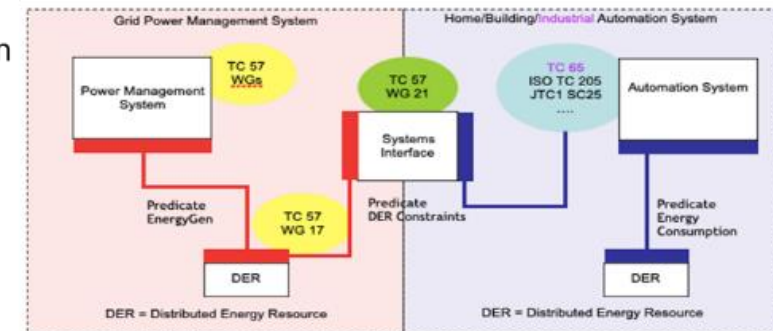
# Using semiotics to get Smart



Formal ontological description of TC57||TC65 Smart Grid Phenomena [OVG University Prof. Diedrich]



Graph-theoretical Simulation of TC57||TC65 Smart Grid Phenomena [TUB DaIN Lab]



Architecture of a TC65||TC57 Smart Grid [RAMI4.0]



**2022**

Annual **INCOSE**  
international workshop

**HYBRID EVENT**

**Torrance, CA, USA**

Jan 29 - Feb 1, 2022

[www.incose.org/IW2022](http://www.incose.org/IW2022)